Specification of Thermoelectric Module TEC1-12722S

Description

The 127 couples, 55 mm × 55 mm size module is made of selected high performance ingot to achieve superior cooling performance and greater delta T up to 70 °C, designed for superior cooling and heating up to 100/200 °C applications. If higher operation or processing temperature is required, please specify, we can design and manufacture the custom made module according to your special requirements.

Features

- High effective cooling and efficiency.
- No moving parts, no noise, and solid-state
- Compact structure, small in size, light in weight
- Environmental friendly, RoHS compliant
- Precise temperature control
- Exceptionally reliable in quality, high performance
- Sustain million thermal cycles with 70 °C temperature change range

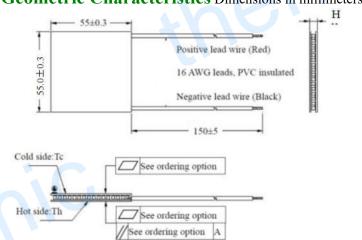
Application

- Food and beverage service refrigerator
- Portable cooler box for cars
- Temperature stabilizer
- Liquid cooling
- CPU cooler and scientific instrument
- Photonic and medical systems

Performance Specification Sheet

| Th (°C) | 27 | 50 | Hot side temperature at environment: dry air, N ₂ | |
|----------------------------|-------|-------|---|--|
| DT _{max} (°C) | 70 | 79 | Temperature Difference between cold and hot side of the module when cooling capacity is zero at cold side | |
| U _{max} (Voltage) | 16 | 17.2 | Voltage applied to the module at DT _{max} | |
| I _{max} (amps) | 18.5 | 18.5 | DC current through the modules at DT _{max} | |
| Q _{Cmax} (Watts) | 185.3 | 202.5 | Cooling capacity at cold side of the module under DT=0 °C | |
| AC resistance (ohms) | 0.68 | 0.74 | The module resistance is tested under AC | |
| Tolerance (%) | ± 10 | | For thermal and electricity parameters | |

Geometric Characteristics Dimensions in millimeters



Ordering Option

| Suffix | Thickness | Flatness/ | Lead wire length(mm) | | |
|--|----------------|------------------|--------------------------|--|--|
| | H (mm) | Parallelism (mm) | Standard/Optional length | | |
| TF | $0:3.3\pm0.1$ | 0: 0.1/0.1 | 150 ± 5 / Specify | | |
| TF | $1:3.3\pm0.05$ | 1: 0.05/0.05 | 150 ± 5 / Specify | | |
| Eq. TF01: Thickness 3.3 + 0.1 (mm) and Flatness 0.05/0.05 (mm) | | | | | |

Manufacturing Options

A. Solder:

older: B. Sealant:

1. T100: BiSn (Tmelt=138°C) 1. NS: No sealing (Standard)

2. T200: CuAgSn (Tmelt = 217°C) 2. SS: Silicone sealant

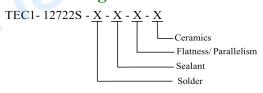
3. T240: SbSn (Tmelt = 240°C) 3. EPS: Epoxy sealant

C. Ceramics: D. Ceramics Surface Options:

1. Alumina (Al₂O₃, white 96%) 1. Blank ceramics (not metalized)

2. Aluminum Nitride (AlN) 2. Metalized

Naming for the Module



TEC1- 12722S- T100 -NS - TF01 - AlO

T100: Solder, BiSn (Melting Point=138 °C)

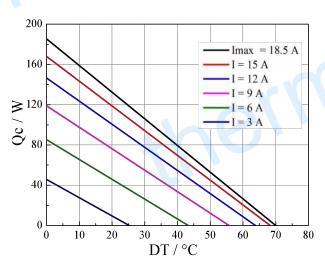
NS: No sealing AlO: Alumina white 96% TF01: Thickness H±0.13(mm) and Flatness/Parallelism 0.1/0.15 (mm)

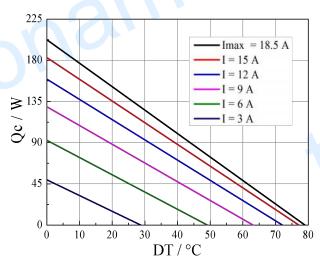
Specification of Thermoelectric Module

TEC1-12722S

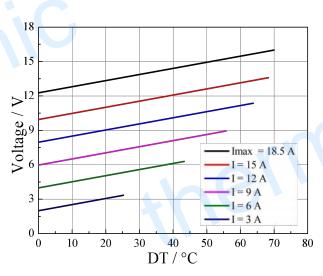
Performance Curves at Th=27 °C

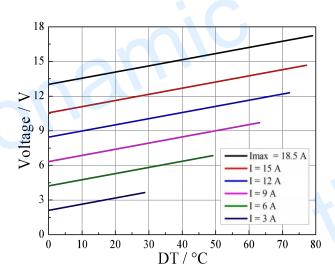
Performance Curves at Th=50 °C



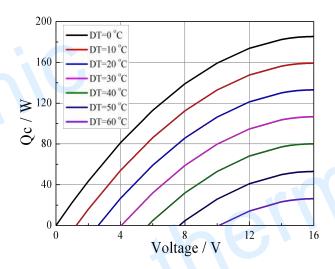


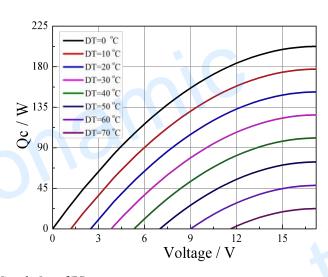
Standard Performance Graph Qc= f(DT)





Standard Performance Graph V = f(DT)





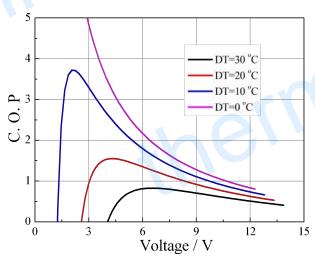
Standard Performance Graph Qc = f(V)

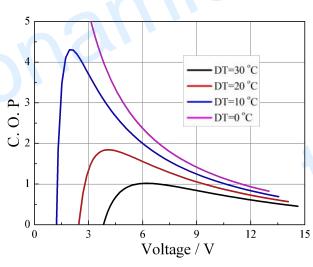
Specification of Thermoelectric Module

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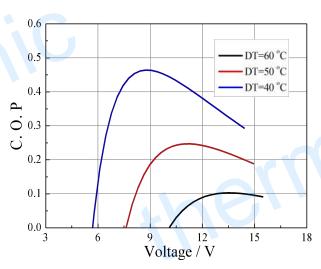
Performance Curves at Th=27 °C

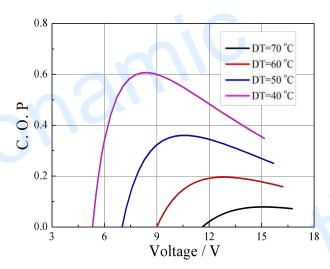
Performance Curves at Th=50 °C





Standard Performance Graph COP = f(V) of DT ranged from 0 to 30 °C





Standard Performance Graph COP = f(V) of DT ranged from 40 to 60/70 °C

Remark: The coefficient of performance (COP) is the cooling power Qc/Input power ($V \times I$).

Operation Cautions

- Attach the cold side of module to the object to be cooled
- Attach the hot side of module to a heat radiator for heat dissipating
- Operation below I_{max} or V_{max}
- Work under DC

Note: All specifications subject to change without notice.